

Schottky Rectifier, 3 A



SMC



FEATURES

- Small foot print, surface mountable
- Very low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Lead (Pb)-free ("PbF" suffix)
- Designed and qualified for industrial level


 Available
RoHS*
 COMPLIANT

DESCRIPTION

The 30BQ100GPbF surface mount Schottky rectifier has been designed for applications requiring low forward drop and small foot prints on PC boards. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

PRODUCT SUMMARY

| | |
|-------------|-------|
| $I_{F(AV)}$ | 3.0 A |
| V_R | 100 V |

MAJOR RATINGS AND CHARACTERISTICS

| SYMBOL | CHARACTERISTICS | VALUES | UNITS |
|-------------|------------------------------|-------------|------------|
| $I_{F(AV)}$ | Rectangular waveform | 3.0 | A |
| V_{RRM} | | 100 | V |
| I_{FSM} | $t_p = 5 \mu s$ sine | 800 | A |
| V_F | 3.0 Apk, $T_J = 125^\circ C$ | 0.62 | V |
| T_J | Range | - 55 to 175 | $^\circ C$ |

VOLTAGE RATINGS

| PARAMETER | SYMBOL | 30BQ100GPbF | UNITS |
|--------------------------------------|-----------|-------------|-------|
| Maximum DC reverse voltage | V_R | 100 | V |
| Maximum working peak reverse voltage | V_{RWM} | | |

ABSOLUTE MAXIMUM RATINGS

| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
|---|-------------|---|--------|-------|
| Maximum average forward current | $I_{F(AV)}$ | 50 % duty cycle at $T_L = 148^\circ C$, rectangular waveform | 3.0 | A |
| | | 50 % duty cycle at $T_L = 138^\circ C$, rectangular waveform | 4.0 | |
| Maximum peak one cycle non-repetitive surge current | I_{FSM} | 5 μs sine or 3 μs rect. pulse | 800 | |
| | | 10 ms sine or 6 ms rect. pulse | 70 | |
| Non-repetitive avalanche energy | E_{AS} | $T_J = 25^\circ C$, $I_{AS} = 1.0 A$, $L = 6 mH$ | 3.0 | mJ |
| Repetitive avalanche current | I_{AR} | Current decaying linearly to zero in 1 μs Frequency limited by T_J maximum $V_A = 1.5 \times V_R$ typical | 0.5 | A |

* Pb containing terminations are not RoHS compliant, exemptions may apply

| ELECTRICAL SPECIFICATIONS | | | | | |
|---------------------------------|----------------|---|-----------------------------------|--------|------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | VALUES | UNITS |
| Maximum forward voltage drop | $V_{FM}^{(1)}$ | 3 A | $T_J = 25\text{ }^\circ\text{C}$ | 0.79 | V |
| | | 6 A | | 0.90 | |
| | | 3 A | $T_J = 125\text{ }^\circ\text{C}$ | 0.62 | |
| | | 6 A | | 0.70 | |
| Maximum reverse leakage current | $I_{RM}^{(1)}$ | $T_J = 25\text{ }^\circ\text{C}$ | $V_R = \text{Rated } V_R$ | 0.1 | mA |
| | | $T_J = 125\text{ }^\circ\text{C}$ | | 5.0 | |
| Maximum junction capacitance | C_T | $V_R = 5\text{ }V_{DC}$ (test signal range 100 kHz to 1 MHz) $25\text{ }^\circ\text{C}$ | | 115 | pF |
| Typical series inductance | L_S | Measured lead to lead 5 mm from package body | | 3.0 | nH |
| Maximum voltage rate of change | dV/dt | Rated V_R | | 10 000 | V/ μ s |

Note

(1) Pulse width < 300 μ s, duty cycle < 2 %

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | |
|---|----------------------|--------------------------------------|----|-------------|--------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | VALUES | UNITS |
| Maximum junction and storage temperature range | $T_J, T_{Stg}^{(1)}$ | | | - 55 to 175 | $^\circ\text{C}$ |
| Maximum thermal resistance, junction to lead | $R_{thJL}^{(2)}$ | DC operation | | 12 | $^\circ\text{C/W}$ |
| Maximum thermal resistance, junction to ambient | R_{thJA} | | 46 | | |
| Approximate weight | | | | 0.24 | g |
| | | | | 0.008 | oz. |
| Marking device | | Case style SMC (similar to DO-214AB) | | V3JG | |

Notes

(1) $\frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}}$ thermal runaway condition for a diode on its own heatsink

(2) Mounted 1" square PCB

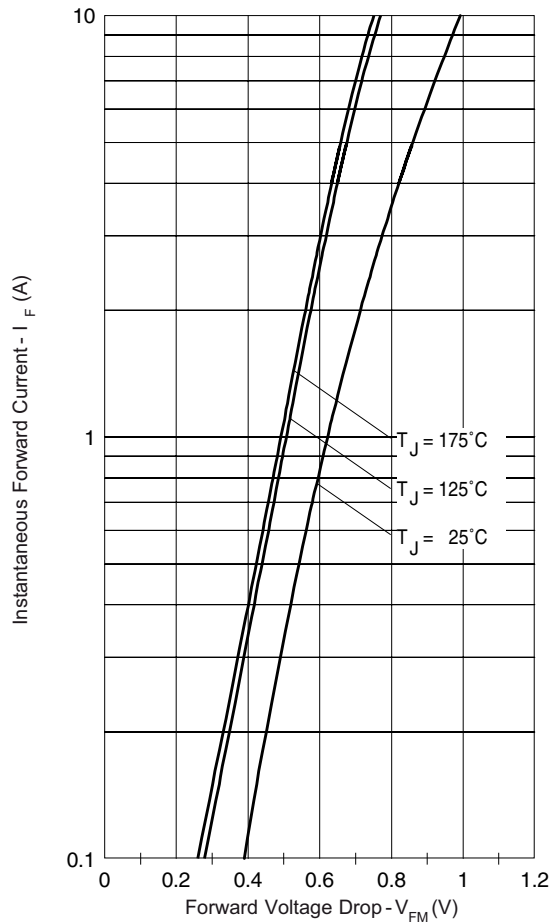


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

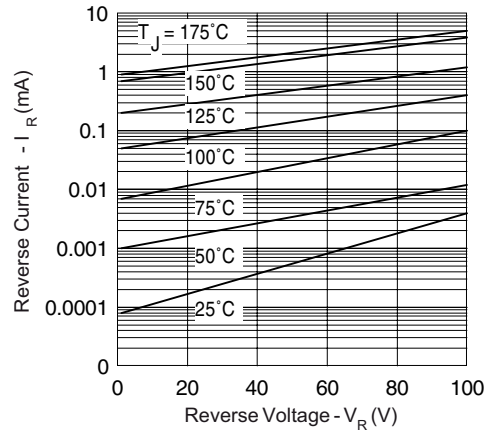


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

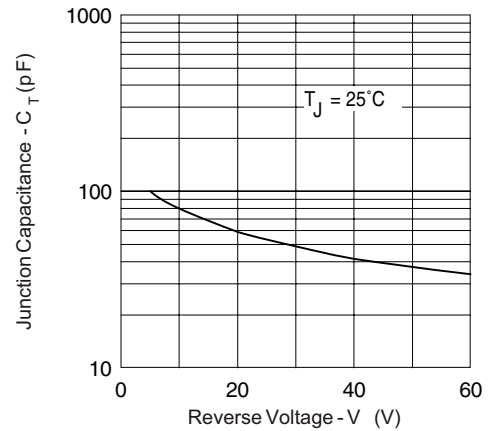


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

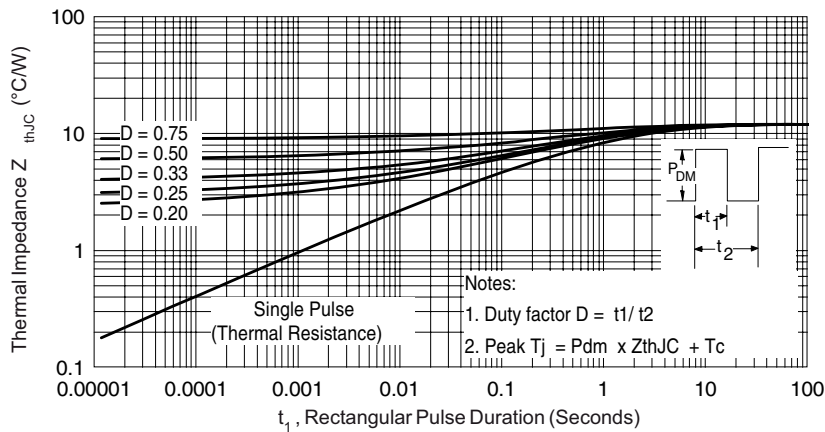


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

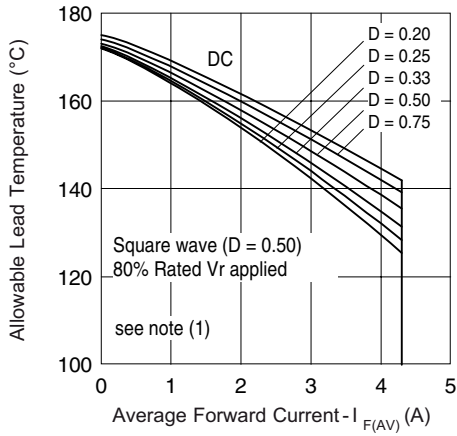


Fig. 5 - Maximum Average Forward Current vs. Allowable Lead Temperature

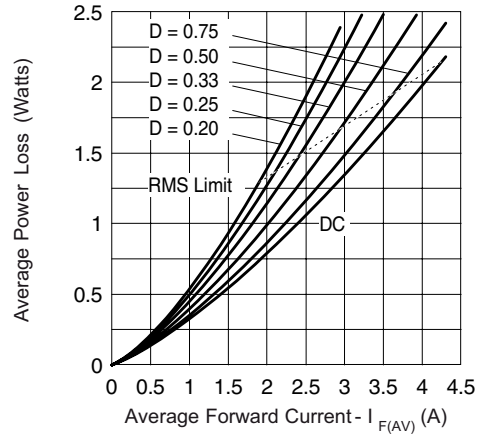


Fig. 6 - Maximum Average Forward Dissipation vs. Average Forward Current

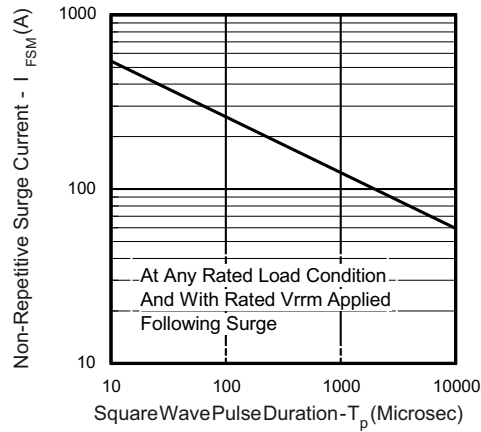


Fig. 7 - Maximum Peak Surge Forward Current vs. Pulse Duration

Note

- (1) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;
 Pd = Forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6);
 Pd_{REV} = Inverse power loss = $V_{R1} \times I_R(1 - D)$; I_R at $V_{R1} = 80\%$ rated V_R



ORDERING INFORMATION TABLE

| | | | | | | | |
|-------------|-----------|----------|----------|------------|----------|-----------|------------|
| Device code | 30 | B | Q | 100 | G | TR | PbF |
| | ① | ② | ③ | ④ | ⑤ | ⑥ | ⑦ |

- 1** - Current rating
- 2** - B = Single lead diode
- 3** - Q = Schottky Q series
- 4** - Voltage rating (100 = 100 V)
- 5** - G = Schottky generation
- 6** -
 - None = Box (1000 pieces)
 - TR = Tape and reel (3000 pieces)
- 7** -
 - None = Standard production
 - PbF = Lead (Pb)-free

| LINKS TO RELATED DOCUMENTS | |
|----------------------------|---|
| Dimensions | http://www.vishay.com/doc?95023 |
| Part marking information | http://www.vishay.com/doc?95029 |
| Packaging information | http://www.vishay.com/doc?95034 |



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